

Programmer's Guide

TPS65219 NVM Programming Guide**ABSTRACT**

The TPS65219 family of power management integrated circuits (PMICs) include a configurable non-volatile memory (NVM) space. This programming guide details the step by step instructions to define the PMIC default configuration and re-program the NVM.

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1 Introduction

The configuration process described in this document writes to the NVM space and is intended to be used in a production line or prototype board. This mechanism is not intended to be used in final applications since the process impacts the regulator outputs and the function of digital pins. The TPS6521905 is an orderable part number, part of the TPS65219 family, created specifically to support custom NVM configuration. [Table 1-1](#) shows the user-programmable variants and the supported package size, temperature and switching mode.

Table 1-1. TPS65219 user-programmable variants

OPN	Package	Temperature	Switching Frequency Supported
TPS6521905RHBR	RHB - 5x5 (0.5mm pitch)	Ta = -40C to 105C Tj = -40C to 125C	Quasi-Fixed Frequency (auto-PFM and forced-PWM)
TPS6521905RSMR	RSM - 4x4 (0.4mm pitch)	Ta = -40C to 105C Tj = -40C to 125C	Quasi-Fixed Frequency (auto-PFM and forced-PWM)
TPS6521905WRHBRQ1	RHB - 5x5 (0.5mm pitch) Wettable Flank	Ta = -40C to 125C Tj = -40C to 150C	Quasi-Fixed Frequency (auto-PFM and forced-PWM)
Available Upon Request	RHB - 5x5 (0.5mm pitch) Wettable Flank	Ta = -40C to 125C Tj = -40C to 150C	Fixed Frequency (out-of-phase switching and spread spectrum available for Buck converters)

TI offers two socketed EVMs, one for each package size, to support NVM programming. TPS65219EVM-SKT is the orderable part number for the 5x5 socketed EVM and TPS65219EVM-RSM is the orderable for the 4x4 socketed EVM.

2 Hardware Setup Overview

The PMIC has two memory spaces, the register map space and the NVM space. Re-programming the NVM is done by first writing to the register map through the serial interface (I2C) and then saving the register settings into the NVM. Because the configuration first involves writing to the register map, which controls the regulator and digital pins, there must be no dependency or need to use the PMIC resources. For example, an external power supply must be used to supply the pull-up resistors of the I2C pins instead of one of the PMIC power resources while reprogramming the NVM.

Table 2-1. Minimum Hardware Requirements for NVM programming

Device pin	Required Connections
VSYS	VSYS voltage must be 3.3V or higher. VSYS must have a minimum of 2.2uF capacitance.
VDD1P8	VDD1P8 must have a 2.2uF capacitance
I2C pins	Pull-up resistors on I2C pins (SDA/SCL) must be supplied by external 3.3V supply. I2C pins of the PMIC must be driven by an external I2C device that can communicate with the PMIC and write to the registers.
EN/PB/VSENSE	EN/PB/VSENSE pin must be connected to VSYS with a pull-up resistor.
AGND	AGND (pin# 15) must be connected to the PCB ground planes through a VIA . Keep the trace from the AGDN pin to the VIA short.
Thermal Pad	The package thermal pad must be connected to the PCB ground plane with a minimum of nine VIAS.

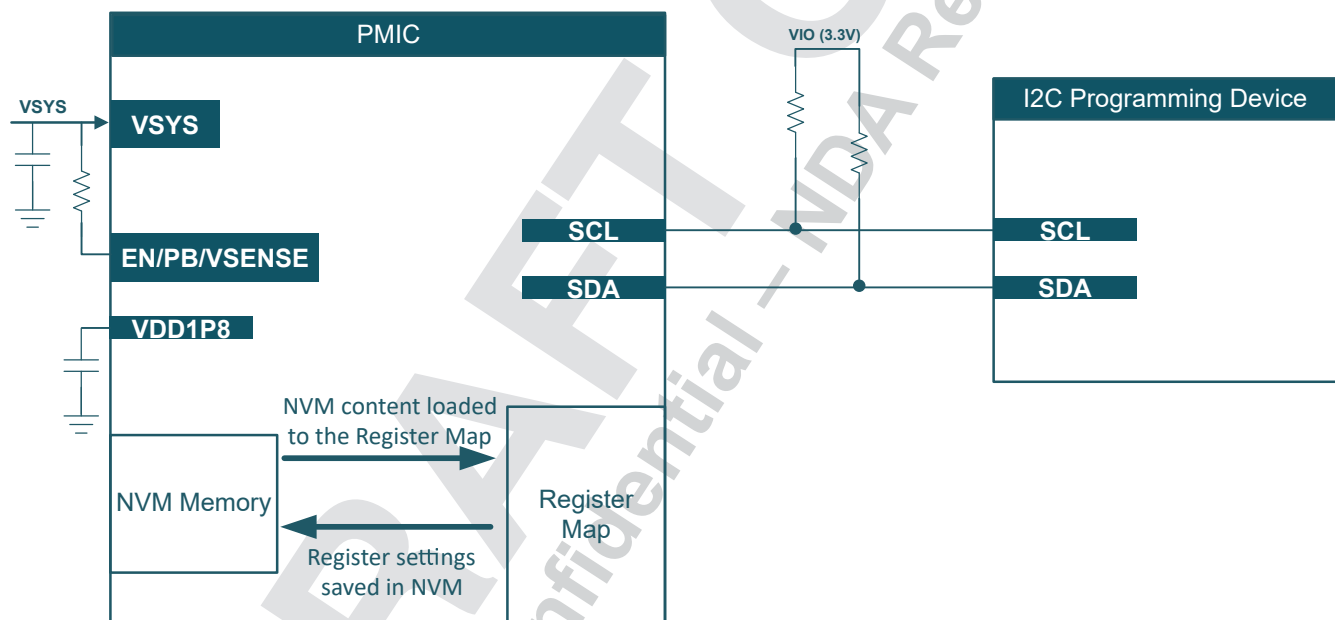


Figure 2-1. Hardware Setup for NVM programming

3 Typical NVM definition flow

1. System Requirements

Identify the system requirements and build a power distribution network (PDN). Voltage/Current, power-up/power-down sequence, low power modes and load transient are typical requirements from processor/SoCs and peripherals.

2. Hardware Setup

The TPS65219 can be programmed using the PMIC socketed EVM or a customer prototype board.

- **Socketed EVM:** The PMIC socketed EVM comes with an onboard MSP340 that can communicate with the PMIC through I2C to re-program the NVM memory. This hardware also integrates a discrete 3.3V LDO that can supply the I2C pull-up resistors while the PMIC rails are OFF.

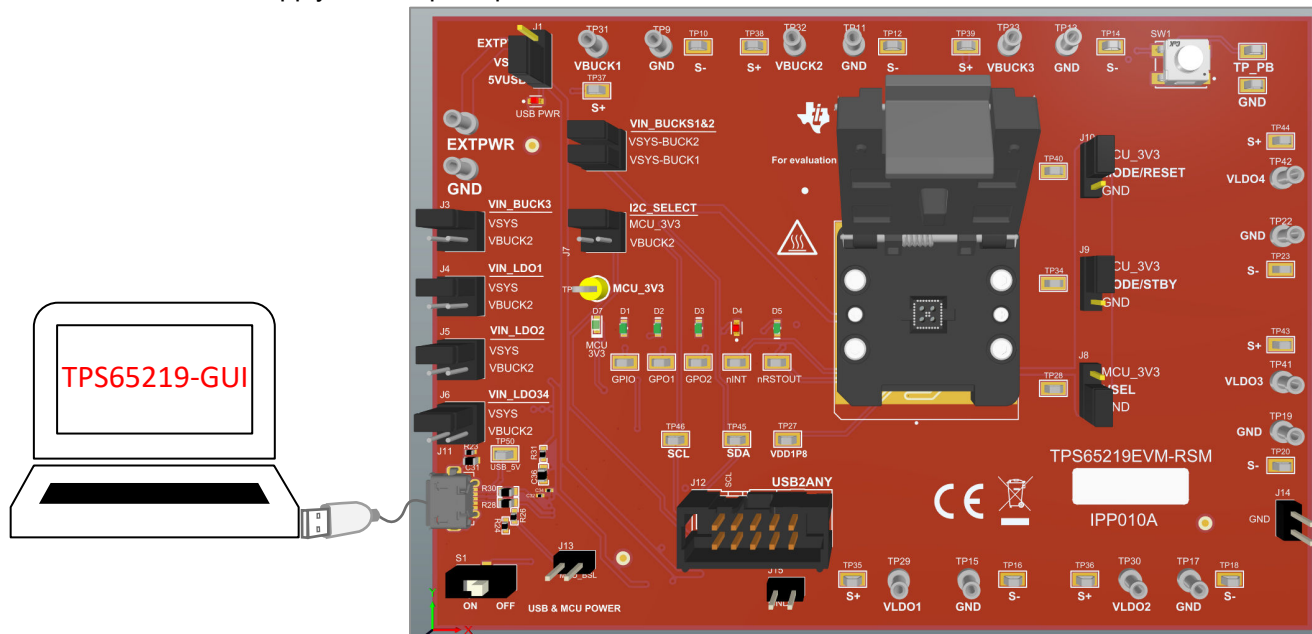


Figure 3-1. Socketed EVM

- **Prototype board:** The user-programmable TPS6521905 NVM comes with the EN/PB/VSENSE pin configured as push-button (FSD disabled) by default. If this pin is pulled up to VSYS as shown in Figure 2-1, then PMIC will stay OFF (Initialize state) after a valid supply is connected to VSYS. This configuration allows to re-program the NVM settings before the power-up sequence is executed. Figure 3-2 shows what customers would need to include in the prototype board to re-program the PMIC NVM. The components required include three test points on GND, SCL, SDA and a 1x3 single row header connector that would allow to select the pull-up supply between the external 3.3V and the PMIC rail that will supply the I2C pins in the normal application. The USB2ANY (available at ti.com) can be used to communicate with the PMIC and re-program the NVM settings.

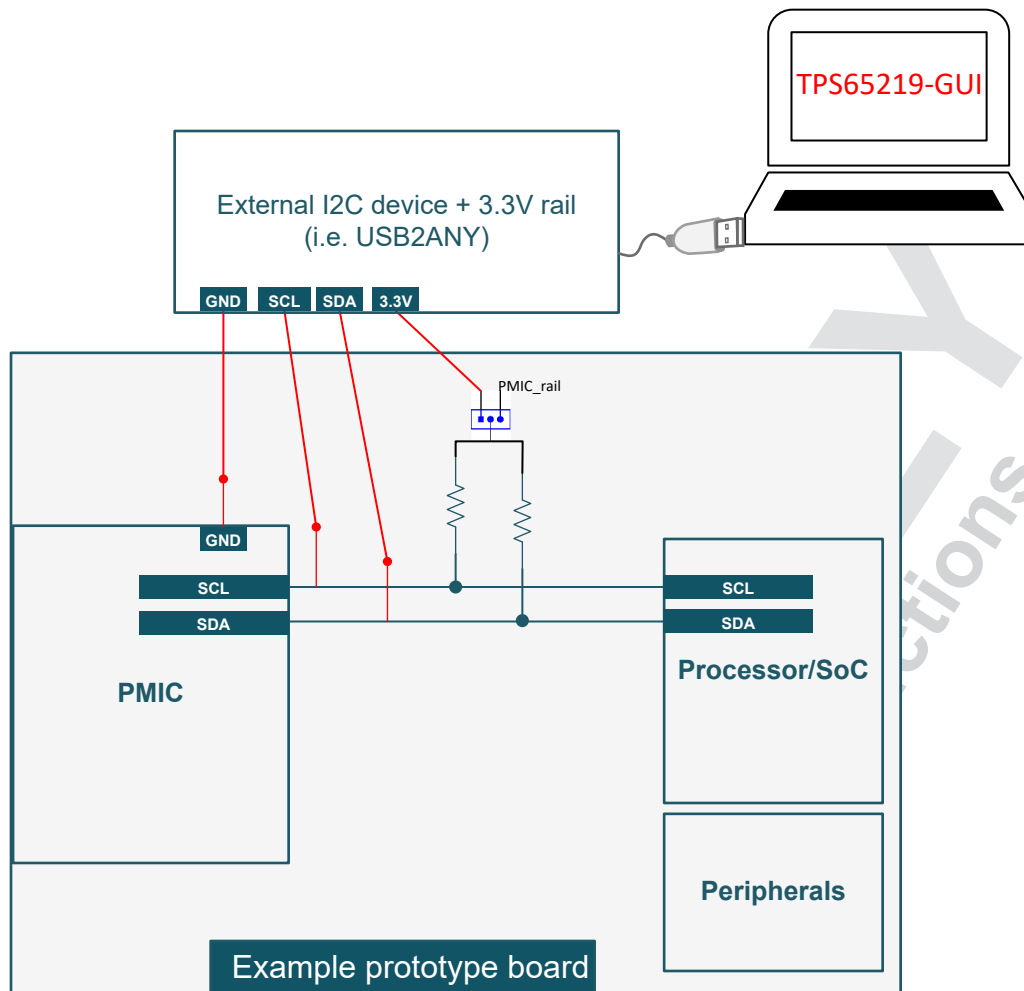


Figure 3-2. Prototype Example

Note

See section "Specifications" and "Detailed Design Procedure" on data sheet for information about recommended external components like inductors, output capacitance, etc.

3. NVM Programming

Follow the [Section 4](#) section to change the register settings and save values into NVM. The [TPS65219-GUI](#) can be used with the socketed EVM or a prototype board+external USB2ANY. Alternatively, customers can use their preferred I2C debugger tool to write to each of the NVM registers without using the TPS65219-GUI. Once the NVM is re-programmed, TI recommends performing a power cycle to confirm register settings were saved into the NVM memory.

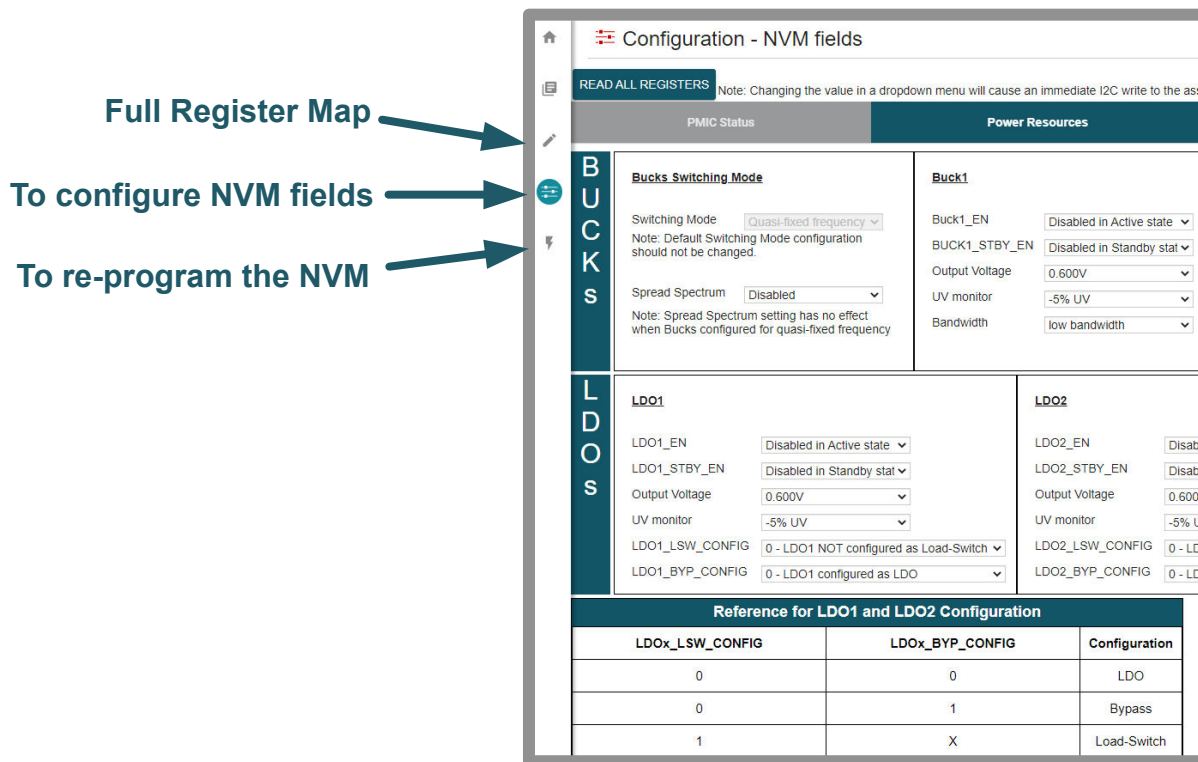


Figure 3-3. TPS65219-GUI

4. NVM Test and validation

NVM settings must be tested to confirm expected PMIC behavior. The list below shows the minimum recommended test. These tests can be performed in the socketed EVM or prototype board. If the socketed EVM was used to re-program the PMIC, the devices can be soldered down into the customer prototype board to test and validate system level functionality. Alternatively, the PMIC on the soldered down [TPS65219EVM](#) can be replaced to test a custom NVM configuration.

- Measure all output voltages
- Collect scope waveform for power-up sequence (include GPIOs if enabled and nRSTOUT)
- Collect scope waveform for power-down sequence (include GPIOs if enabled and nRSTOUT)
- Test EN/PB/VSENSE pin function and polarity
- Test multi-function pins (VSEL, MODE/STBY, MODE/RESET) configuration and polarity

Note

The socketed EVM can be used for re-programming and basic test (For example: measuring output voltages, collecting power-up sequence waveforms, etc) but must not be used to test specific performance parameters like load transient and efficiency because the socket and it's layout introduce parasitic that do not represent conditions on real applications.

4 Programming Instructions

This section describes the steps required to program the PMIC NVM. The programming process consists of two primary steps; Changing the register settings and saving the new values into the NVM memory. TI recommends programming the NVM in Initialize state, where VSYS is supplied but all the PMIC outputs and monitors are OFF.

Figure 4-1 shows the steps to reprogram the device. The first command consists of an I2C OFF request to send the device to Initialize state. This is only needed if the device is not in Initialize state. The second I2C command enables I2C communication for NVM register settings. The same command disables the rails discharge and also enables an internal oscillator. The third step requires updating register settings to match specific application requirements. Once the register settings are updated, the new values are saved into the NVM by writing 0x0A to register address 0x34. The last step "Validation" is optional and consist of an I2C command that compares register settings with NVM content.

Note

The first I2C command (I2C OFF request) is only needed if the PMIC is not in Initialize state. The user programmable OPN TPS6521905 comes with the EN/PB/VSENSE pin configured as "push-button" with the FSD feature disabled by default. When configured as PB, the device detects an ON-request when the pin is pulled low. If this pin has a pull-up to VSYS, then PMIC will stay in Initialize state after VSYS is supplied.

1 Send I2C OFF Request	Register Address: 0x29 Data: 0x01 (I2C_OFF_REQ)
2 Enable I2C Communication	Register Address: 0x34 Data: 0x09 (EN_OSC_DIY)
3 Update register settings	This step requires updating the correct register settings to match specific application requirements
4 NVM Programming	Register Address: 0x34 Data: 0x0A (EN_OSC_DIY)
5 NVM Validation	Register Address: 0x34 Data: 0x07 (EN_OSC_DIY)

Figure 4-1. NVM Programming

4.1 Configuring Enable Settings

The PMIC has an Active and Standby state where rails can be enabled or disabled. The state change can be triggered by the MODE/STBY pin when configured as STBY.

- [Figure 4-2](#) shows the settings to be changed when using the TPS65219-GUI

- Table 4-1 show the register fields to be written when NOT using the TPS65219-GUI.

Configuration - NVM fields

READ ALL REGISTERS Note: Changing the value in a dropdown menu will cause an immediate I2C write to the associated register unless immediate write setting is changed on Register Map page.

PMIC Status	Power Resources	Sequence	Digital Pins Configuration	Mask Settings												
BUCKS	Bucks Switching Mode Switching Mode: Quasi-fixed frequency Note: Default Switching Mode configuration should not be changed. Spread Spectrum: Disabled Note: Spread Spectrum setting has no effect when Bucks configured for quasi-fixed frequency	Buck1 Buck1_EN: Disabled in Active state BUCK1_STBY_EN: Disabled in Standby state Output Voltage: 0.600V UV monitor: -5% UV Bandwidth: low bandwidth	Buck2 Buck2_EN: Disabled in Active state BUCK2_STBY_EN: Disabled in Standby state Output Voltage: 0.600V UV monitor: -5% UV Bandwidth: low bandwidth Phase Config: 0 degrees	Buck3 Buck3_EN: Disabled in Active state BUCK3_STBY_EN: Disabled in Standby state Output Voltage: 0.600V UV monitor: -5% UV Bandwidth: low bandwidth Phase Config: 0 degrees												
LDOs	LDO1 LDO1_EN: Disabled in Active state LDO1_STBY_EN: Disabled in Standby state Output Voltage: 0.600V UV monitor: -5% UV LDO1_LSW_CONFIG: 0 - LDO1 NOT configured as Load-Switch LDO1_BYP_CONFIG: 0 - LDO1 configured as LDO	LDO2 LDO2_EN: Disabled in Active state LDO2_STBY_EN: Disabled in Standby state Output Voltage: 0.600V UV monitor: -5% UV LDO2_LSW_CONFIG: 0 - LDO2 NOT configured as Load-Switch LDO2_BYP_CONFIG: 0 - LDO2 configured as LDO	LDO3 LDO3_EN: Disabled in Active state LDO3_STBY_EN: Disabled in Standby state Output Voltage: 1.200V UV monitor: -5% UV Configuration: LDO Mode Power-Up Ramp: Fast ramp	LDO4 LDO4_EN: Disabled in Active state LDO4_STBY_EN: Disabled in Standby state Output Voltage: 1.200V UV monitor: -5% UV Configuration: LDO Mode Power-Up Ramp: Fast ramp												
Reference for LDO1 and LDO2 Configuration <table border="1"> <thead> <tr> <th>LDOx_LSW_CONFIG</th> <th>LDOx_BYP_CONFIG</th> <th>Configuration</th> </tr> </thead> <tbody> <tr> <td>0</td> <td>0</td> <td>LDO</td> </tr> <tr> <td>0</td> <td>1</td> <td>Bypass</td> </tr> <tr> <td>1</td> <td>X</td> <td>Load-Switch</td> </tr> </tbody> </table>					LDOx_LSW_CONFIG	LDOx_BYP_CONFIG	Configuration	0	0	LDO	0	1	Bypass	1	X	Load-Switch
LDOx_LSW_CONFIG	LDOx_BYP_CONFIG	Configuration														
0	0	LDO														
0	1	Bypass														
1	X	Load-Switch														

Figure 4-2. Enable settings using the TPS65219-GUI

Table 4-1. NVM registers for enable settings

	Register Address	Bit		Settings
		Bit #	Field Name	
Enable rails in Active state	0x02	6	LDO4_EN	0h = Disabled 1h = Enabled
		5	LDO3_EN	0h = Disabled 1h = Enabled
		4	LDO2_EN	0h = Disabled 1h = Enabled
		3	LDO1_EN	0h = Disabled 1h = Enabled
		2	BUCK3_EN	0h = Disabled 1h = Enabled
		1	BUCK2_EN	0h = Disabled 1h = Enabled
		0	BUCK1_EN	0h = Disabled 1h = Enabled

Table 4-1. NVM registers for enable settings (continued)

	Register Address	Bit		Settings
		Bit #	Field Name	
Enable rails in Standby state	0x21	6	LDO4_STBY_EN	0h = Disabled 1h = Enabled
		5	LDO3_STBY_EN	0h = Disabled 1h = Enabled
		4	LDO2_STBY_EN	0h = Disabled 1h = Enabled
		3	LDO1_STBY_EN	0h = Disabled 1h = Enabled
		2	BUCK3_STBY_EN	0h = Disabled 1h = Enabled
		1	BUCK2_STBY_EN	0h = Disabled 1h = Enabled
		0	BUCK1_STBY_EN	0h = Disabled 1h = Enabled

4.2 Configuring the Bucks

There are several settings that can be programmed for the Buck converters. These include the output voltages, under voltage (UV) monitoring, bandwidth, among others.

- Figure 4-3 shows the settings to be changed when using the TPS65219-GUI
- Table 4-2, Table 4-3, Table 4-4 and Table 4-5 show the register fields to be written when NOT using the TPS65219-GUI

Configuration - NVM fields

READ ALL REGISTERS Note: Changing the value in a dropdown menu will cause an immediate I2C write to the associated register unless immediate write setting is changed on Register Map page.

PMIC Status	Power Resources	Sequence	Digital Pins Configuration	Mask Settings
BUCKS	Bucks Switching Mode Switching Mode: Quasi-fixed frequency Note: Default Switching Mode configuration should not be changed. Spread Spectrum: Disabled Note: Spread Spectrum setting has no effect when Bucks configured for quasi-fixed frequency	Buck1 Buck1_EN: Disabled in Active state BUCK1_STBY_EN: Disabled in Standby stat Output Voltage: 0.600V UV monitor: -5% UV Bandwidth: low bandwidth	Buck2 Buck2_EN: Disabled in Active state BUCK2_STBY_EN: Disabled in Standby stat Output Voltage: 0.600V UV monitor: -5% UV Bandwidth: low bandwidth Phase Config: 0 degrees	Buck3 Buck3_EN: Disabled in Active state BUCK3_STBY_EN: Disabled in Standby stat Output Voltage: 0.600V UV monitor: -5% UV Bandwidth: low bandwidth Phase Config: 0 degrees
LDOs	LDO1 LDO1_EN: Disabled in Active state LDO1_STBY_EN: Disabled in Standby stat Output Voltage: 0.600V UV monitor: -5% UV LDO1_LSW_CONFIG: 0 - LDO1 NOT configured as Load-Switch LDO1_BYP_CONFIG: 0 - LDO1 configured as LDO	LDO2 LDO2_EN: Disabled in Active state LDO2_STBY_EN: Disabled in Standby stat Output Voltage: 0.600V UV monitor: -5% UV LDO2_LSW_CONFIG: 0 - LDO2 NOT configured as Load-Switch LDO2_BYP_CONFIG: 0 - LDO2 configured as LDO	LDO3 LDO3_EN: Disabled in Active state LDO3_STBY_EN: Disabled in Standby stat Output Voltage: 1.200V UV monitor: -5% UV Configuration: LDO Mode Power-Up Ramp: Fast ramp	LDO4 LDO4_EN: Disabled in Active state LDO4_STBY_EN: Disabled in Standby stat Output Voltage: 1.200V UV monitor: -5% UV Configuration: LDO Mode Power-Up Ramp: Fast ramp

LDOx_LSW_CONFIG	LDOx_BYP_CONFIG	Configuration
0	0	LDO
0	1	Bypass
1	X	Load-Switch

Figure 4-3. Bucks settings using the TPS65219-GUI

Table 4-2. NVM registers for Buck1 configuration

	Register Address	Bit		Settings
		Bit #	Field Name	
Bandwidth	0x0A	7	BUCK1_BW_SEL	0h = low bandwidth 1h = high bandwidth
UV monitoring		6	BUCK1_UV_THR_SEL	0h = -5% UV detection level 1h = -10% UV detection level
Output Voltage		5-0	BUCK1_VSET	see register map on data sheet

Table 4-3. NVM registers for Buck2 configuration

	Register Address	Bit		Settings
		Bit #	Field Name	
Bandwidth	0x09	7	BUCK2_BW_SEL	0h = low bandwidth 1h = high bandwidth
UV monitoring		6	BUCK2_UV_THR_SEL	0h = -5% UV detection level 1h = -10% UV detection level
Output Voltage		5-0	BUCK2_VSET	see register map on data sheet

Table 4-4. NVM registers for Buck3 configuration

	Register Address	Bit		Settings
		Bit #	Field Name	
Bandwidth	0x08	7	BUCK3_BW_SEL	0h = low bandwidth 1h = high bandwidth
UV monitoring		6	BUCK3_UV_THR_SEL	0h = -5% UV detection level 1h = -10% UV detection level
Output Voltage		5-0	BUCK3_VSET	see register map on data sheet

Table 4-5. NVM registers for Switching Mode (Only applicable if BUCK_FF_ENABLE = 1h)

	Register Address	Bit		Settings
		Bit #	Field Name	
Spread Spectrum	0x03	5	BUCK_SS_ENABLE	0h = Spread spectrum disabled 1h = Spread spectrum enabled
Switching Mode		4	BUCK_FF_ENABLE	DO NOT CHANGE THIS BIT
Buck2/Buck3 phase cnonfig		3-2	BUCK3_PHASE_CONFIG	0h = 0 degrees 1h = 90 degrees 2h = 180 degrees 3h = 270 degrees
		1-0	BUCK2_PHASE_CONFIG	0h = 0 degrees 1h = 90 degrees 2h = 180 degrees 3h = 270 degrees

4.3 Configuring LDOs

There are several settings that can be programmed for the LDO regulators. These include the output voltages, under voltage (UV) monitoring, among others.

- [Figure 4-4](#) shows the settings to be changed when using the TPS65219-GUI
- [Table 4-6](#), [Table 4-7](#), [Table 4-8](#) and [Table 4-9](#) show the register fields to be written when NOT using the TPS65219-GUI.

Configuration - NVM fields

READ ALL REGISTERS Note: Changing the value in a dropdown menu will cause an immediate I2C write to the associated register unless immediate write setting is changed on Register Map page.

PMIC Status	Power Resources	Sequence	Digital Pins Configuration	Mask Settings												
BUCKS	Bucks Switching Mode Switching Mode: Quasi-fixed frequency Note: Default Switching Mode configuration should not be changed. Spread Spectrum: Disabled Note: Spread Spectrum setting has no effect when Bucks configured for quasi-fixed frequency.	Buck1 Buck1_EN: Disabled in Active state BUCK1_STBY_EN: Disabled in Standby stat Output Voltage: 0.600V UV monitor: -5% UV Bandwidth: low bandwidth	Buck2 Buck2_EN: Disabled in Active state BUCK2_STBY_EN: Disabled in Standby stat Output Voltage: 0.600V UV monitor: -5% UV Bandwidth: low bandwidth Phase Config: 0 degrees	Buck3 Buck3_EN: Disabled in Active state BUCK3_STBY_EN: Disabled in Standby stat Output Voltage: 0.600V UV monitor: -5% UV Bandwidth: low bandwidth Phase Config: 0 degrees												
LDOs	LDO1 LDO1_EN: Disabled in Active state LDO1_STBY_EN: Disabled in Standby stat Output Voltage: 0.600V UV monitor: -5% UV LDO1_LSW_CONFIG: 0 - LDO1 NOT configured as Load-Switch LDO1_BYP_CONFIG: 0 - LDO1 configured as LDO	LDO2 LDO2_EN: Disabled in Active state LDO2_STBY_EN: Disabled in Standby stat Output Voltage: 0.600V UV monitor: -5% UV LDO2_LSW_CONFIG: 0 - LDO2 NOT configured as Load-Switch LDO2_BYP_CONFIG: 0 - LDO2 configured as LDO	LDO3 LDO3_EN: Disabled in Active state LDO3_STBY_EN: Disabled in Standby stat Output Voltage: 1.200V UV monitor: -5% UV Configuration: LDO Mode Power-Up Ramp: Fast ramp	LDO4 LDO4_EN: Disabled in Active state LDO4_STBY_EN: Disabled in Standby stat Output Voltage: 1.200V UV monitor: -5% UV Configuration: LDO Mode Power-Up Ramp: Fast ramp												
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LDOx_LSW_CONFIG	LDOx_BYP_CONFIG	Configuration														
0	0	LDO														
0	1	Bypass														
1	X	Load-Switch														

Figure 4-4. LDOs settings using the TPS65219-GUI

Table 4-6. NVM registers for LDO1 settings

	Register Address	Bit		Settings
		Bit #	Field Name	
Output Voltage	0x07	5-0	LDO1_VSET	see register map on data sheet
Configuration		7	LDO1_LSW_CONFIG	0h = LDO1 NOT configured as load-switch 1h = LDO1 configured as Load-switch
		6	LDO1_BYP_CONFIG	0h = LDO1 configured as LDO 1h = LDO1 configured as Bypass (only applicable if LDO1_LSW_CONFIG 0x0)
UV monitoring	0x1E	3	LDO1_UV_THR	0h = -5% UV 1h = -10% UV

Table 4-7. NVM registers for LDO2 settings

	Register Address	Bit		Settings
		Bit #	Field Name	
Output Voltage	0x06	7	LDO2_VSET	see register map on data sheet
Configuration		6	LDO2_LSW_CONFIG	0h = LDO1 NOT configured as load-switch 1h = LDO1 configured as Load-switch
		5-0	LDO2_BYP_CONFIG	0h = LDO1 configured as LDO 1h = LDO1 configured as Bypass (only applicable if LDO1_LSW_CONFIG 0x0)
UV Monitoring	0x1E	4	LDO2_UV_THR	0h = -5% UV 1h = -10% UV

Table 4-8. NVM registers for LDO3 settings

	Register Address	Bit		Settings
		Bit #	Field Name	
Output Voltage	0x05	5-0	LDO3_VSET	see register map on data sheet
Configuration		6	LDO3_LSW_CONFIG	0h = LDO Mode 1h = LSW Mode
Ramp		7	LDO3_SLOW_PU_RAMP	0h = Fast ramp for power-up 1h = Slow ramp for power-up

Table 4-8. NVM registers for LDO3 settings (continued)

	Register Address	Bit		Settings
		Bit #	Field Name	
UV Monitoring	0x1E	5	LDO3_UV_THR	0h = -5% UV 1h = -10% UV

Table 4-9. NVM registers for LDO4 settings

	Register Address	Bit		Settings
		Bit #	Field Name	
Output Voltage	0x04	5-0	LDO4_VSET	see register map on data sheet
Configuration		6	LDO4_LSW_CONFIG	0h = LDO Mode 1h = LSW Mode
Ramp		7	LDO4_SLOW_PU_RAMP	0h = Fast ramp for power-up 1h = Slow ramp for power-up
UV Monitoring	0x1E	6	LDO4_UV_THR	0h = -5% UV 1h = -10% UV

4.4 Configuring GPIOs

GPIOs can be used to enable to enable external discretes. GPIO can also be used for multi-PMIC configuration to sync the power-up and power-down sequence between two TPS65219 devices.

- [Figure 4-5](#) shows the settings to be changed when using the TPS65219-GUI
- [Table 4-10](#), [Table 4-11](#) show the register fields to be written when NOT using the TPS65219-GUI.

Configuration - NVM fields

READ ALL REGISTERS Note: Changing the value in a dropdown menu will cause an immediate I2C write to the associated register unless immediate write setting is changed on Register Map page.

PMIC Status Power Resources Sequence Digital Pins Configuration

ENABLE

EN / PB / VSENSE (pin# 25)

Pin Configuration: Enable
Deglitch: Short Deglitch
FSD: Disable

Deglitch Reference		
Pin Configuration	Short_deglitch(TYP)	Long_deglitch(TYP)
Enable	120us	50ms
VSENSE	120us	50ms
Push-Button	200ms	600ms

MULTI

VSEL_SD / VSEL_DDR (pin# 12)

Pin Configuration: DDR
Rail Selection: LDO1
VSEL_SD_POLARITY: 0
Note: See Table "VSEL_SD/VSEL_DDR configuration options" in the data sheet for more information about pin polarity
VSEL_SD Control via I2C: 1.6V
Note: VSEL_SD Control has no effect if pin 12 configured as SD

MODE / RESET (pin#28)

Pin Configuration: MODE
Reset Selection: Cold Reset
MODE_RESET_POLARITY: 0
Note: See Table "MODE, STBY and RESET configuration" in the data sheet for more information about pin polarity

MODE / STBY (pin# 31)

Pin Configuration: MODE
MODE_STBY_POLARITY: 0
Note: See Table "MODE, STBY and RESET configuration" in the data sheet for more information about pin polarity
BUCK MODE Control via I2C: Auto PFM

GPIOs

GPIO (pin# 16)

GPIO Config: Single-device config
GPIO Active State: Disabled
GPIO_Standby State: Disabled

GPO1 (pin# 8)

GPO1 Active State: Disabled
GPO1 Standby State: Disabled

GPO2 (pin# 17)

GPO2 Active State: Disabled
GPO2 Standby State: Disabled

Figure 4-5. GPIOs Configuration

Table 4-10. NVM registers for GPIO settings

	Register Address	Bit		Settings
		Bit #	Field Name	
Enable settings in Active state	0x1E	2	GPIO_EN	0h = Disabled. The output state is low. 1h = Enabled. The output state is Hi-Z.
		1	GPO2_EN	0h = Disabled. The output state is low. 1h = Enabled. The output state is Hi-Z.
		0	GPO1_EN	0h = Disabled. The output state is low. 1h = Enabled. The output state is Hi-Z.
Enable settings in Standby state	0x22	2	GPIO_STBY_EN	0h = Disabled. The output state is low. 1h = Enabled. The output state is Hi-Z.
		1	GPO2_STBY_EN	0h = Disabled. The output state is low. 1h = Enabled. The output state is Hi-Z.
		0	GPO1_STBY_EN	0h = Disabled. The output state is low. 1h = Enabled. The output state is Hi-Z.

Table 4-11. NVM register for multi-PMIC Configuration

	Register Address	Bit		Settings
		Bit #	Field Name	
GPO2 configuration	0x1F	3	MULTI_DEVICE_ENABLE	0h = Single-device configuration 1h = Multi-device configuration

4.5 Configuring Sequence

The process to configure the PMIC sequence consist of the following two steps:

- Power-up/Power-down slot assignment: The slot assignment defines the order in which rails will be turned ON or OFF. Each of the PMIC rails must have a slot assigned. There are 16 slots available (0-15). Multiple rails (including GPIOs) can be assigned to the same slot so they be enabled at the same time.
- Power-up/Power-down slot duration: The slot duration is the timing between the start of one slot to the start of the next slot. For example, if Buck1 is assigned to slot0 with a 3ms duration and Buck2 is assigned to slot 1, then Buck2 will be turned ON 3ms after Buck1.

Note

The slot duration does not dictate how long it takes for the rails to ramp. The slot duration only specifies how long the PMIC waits before enabling (or disabling) the rails that were assigned to the next slot.

- [Figure 4-6](#) shows the settings to be changed when using the TPS65219-GUI
- [Table 4-12](#), [Table 4-13](#), [Table 4-14](#) and [Table 4-15](#) show the register fields to be written when NOT using the TPS65219-GUI.

Configuration - NVM fields

READ ALL REGISTERS Note: Changing the value in a dropdown menu will cause an immediate I2C write to the associated register unless immediate write setting is changed on Register Map page.

PMIC Status Power Resources Sequence Digital Pins Configuration

Power-Up Sequence

Slot# Assignment		Slot Duration	
Buck1	slot_0	Slot_0	0 ms
Buck2	slot_0	Slot_1	0 ms
Buck3	slot_0	Slot_2	0 ms
LDO1	slot_0	Slot_3	0 ms
LDO2	slot_0	Slot_4	0 ms
LDO3	slot_0	Slot_5	0 ms
LDO4	slot_0	Slot_6	0 ms
GPIO	slot_0	Slot_7	0 ms
GPO1	slot_0	Slot_8	0 ms
GPO2	slot_0	Slot_9	0 ms
nRSTOUT	slot_0	Slot_10	0 ms
		Slot_11	0 ms
		Slot_12	0 ms
		Slot_13	0 ms
		Slot_14	0 ms
		Slot_15	0 ms

Power-Down Sequence

Slot# Assignment		Slot Duration	
Buck1	slot_0	Slot_0	0 ms
Buck2	slot_0	Slot_1	0 ms
Buck3	slot_0	Slot_2	0 ms
LDO1	slot_0	Slot_3	0 ms
LDO2	slot_0	Slot_4	0 ms
LDO3	slot_0	Slot_5	0 ms
LDO4	slot_0	Slot_6	0 ms
GPIO	slot_0	Slot_7	0 ms
GPO1	slot_0	Slot_8	0 ms
GPO2	slot_0	Slot_9	0 ms
nRSTOUT	slot_0	Slot_10	0 ms
		Slot_11	0 ms
		Slot_12	0 ms
		Slot_13	0 ms
		Slot_14	0 ms
		Slot_15	0 ms

Figure 4-6. Sequence Configuration

Table 4-12. Power-Up Sequence - Slot Assignments

	Register Address	Bit		Settings
		Bit#	Field Name	
Power-up Sequence Slot Assignment	0x11	7-4	BUCK1_SEQUENCE_ON_SLOT	see register map on data sheet
	0x10	7-4	BUCK2_SEQUENCE_ON_SLOT	see register map on data sheet
	0xF	7-4	BUCK3_SEQUENCE_ON_SLOT	see register map on data sheet
	0xE	7-4	LDO1_SEQUENCE_ON_SLOT	see register map on data sheet
	0xD	7-4	LDO2_SEQUENCE_ON_SLOT	see register map on data sheet
	0xC	7-4	LDO3_SEQUENCE_ON_SLOT	see register map on data sheet
	0xB	7-4	LDO4_SEQUENCE_ON_SLOT	see register map on data sheet
	0x15	7-4	GPO1_SEQUENCE_ON_SLOT	see register map on data sheet
	0x14	7-4	GPO2_SEQUENCE_ON_SLOT	see register map on data sheet
	0x13	7-4	GPIO_SEQUENCE_ON_SLOT	see register map on data sheet
	0x12	7-4	nRST_SEQUENCE_ON_SLOT	see register map on data sheet

Table 4-13. Power-UP Sequence - Slot Duration

	Register Address	Bit		Settings
		Bit#	Field Name	
Power-up Sequence Slot Duration	0x16	7-6	POWER_UP_SLOT_0_DURATION	see register map on data sheet
		5-4	POWER_UP_SLOT_1_DURATION	see register map on data sheet
		3-2	POWER_UP_SLOT_2_DURATION	see register map on data sheet
		1-0	POWER_UP_SLOT_3_DURATION	see register map on data sheet
	0x17	7-6	POWER_UP_SLOT_4_DURATION	see register map on data sheet
		5-4	POWER_UP_SLOT_5_DURATION	see register map on data sheet
		3-2	POWER_UP_SLOT_6_DURATION	see register map on data sheet
		1-0	POWER_UP_SLOT_7_DURATION	see register map on data sheet
	0x18	7-6	POWER_UP_SLOT_8_DURATION	see register map on data sheet
		5-4	POWER_UP_SLOT_9_DURATION	see register map on data sheet
		3-2	POWER_UP_SLOT_10_DURATION	see register map on data sheet
		1-0	POWER_UP_SLOT_11_DURATION	see register map on data sheet
	0x19	7-6	POWER_UP_SLOT_12_DURATION	see register map on data sheet
		5-4	POWER_UP_SLOT_13_DURATION	see register map on data sheet
		3-2	POWER_UP_SLOT_14_DURATION	see register map on data sheet
		1-0	POWER_UP_SLOT_15_DURATION	see register map on data sheet

Table 4-14. Power-Down Sequence - Slot Assignments

	Register Address	Bit		Settings
		Bit#	Field Name	
Power-down Sequence Slot Assignment	0x11	7-4	BUCK1_SEQUENCE_OFF_SLOT	see register map on data sheet
	0x10	7-4	BUCK2_SEQUENCE_OFF_SLOT	see register map on data sheet
	0xF	7-4	BUCK3_SEQUENCE_OFF_SLOT	see register map on data sheet
	0xE	7-4	LDO1_SEQUENCE_OFF_SLOT	see register map on data sheet
	0xD	7-4	LDO2_SEQUENCE_OFF_SLOT	see register map on data sheet
	0xC	7-4	LDO3_SEQUENCE_OFF_SLOT	see register map on data sheet
	0xB	7-4	LDO4_SEQUENCE_OFF_SLOT	see register map on data sheet
	0x15	7-4	GPO1_SEQUENCE_OFF_SLOT	see register map on data sheet
	0x14	7-4	GPO2_SEQUENCE_OFF_SLOT	see register map on data sheet
	0x13	7-4	GPIO_SEQUENCE_OFF_SLOT	see register map on data sheet
	0x12	7-4	nRST_SEQUENCE_OFF_SLOT	see register map on data sheet

Table 4-15. Power-down Sequence - Slot Duration

	Register Address	Bit		Settings
		Bit#	Field Name	
Power-down Sequence Slot Duration	0x1A	7-6	POWER_DOWN_SLOT_0_DURATION	see register map on data sheet
		5-4	POWER_DOWN_SLOT_1_DURATION	see register map on data sheet
		3-2	POWER_DOWN_SLOT_2_DURATION	see register map on data sheet
		1-0	POWER_DOWN_SLOT_3_DURATION	see register map on data sheet
	0x1B	7-6	POWER_DOWN_SLOT_4_DURATION	see register map on data sheet
		5-4	POWER_DOWN_SLOT_5_DURATION	see register map on data sheet
		3-2	POWER_DOWN_SLOT_6_DURATION	see register map on data sheet
		1-0	POWER_DOWN_SLOT_7_DURATION	see register map on data sheet
	0x1C	7-6	POWER_DOWN_SLOT_8_DURATION	see register map on data sheet
		5-4	POWER_DOWN_SLOT_9_DURATION	see register map on data sheet
		3-2	POWER_DOWN_SLOT_10_DURATION	see register map on data sheet
		1-0	POWER_DOWN_SLOT_11_DURATION	see register map on data sheet
	0x1D	7-6	POWER_DOWN_SLOT_12_DURATION	see register map on data sheet
		5-4	POWER_DOWN_SLOT_13_DURATION	see register map on data sheet
		3-2	POWER_DOWN_SLOT_14_DURATION	see register map on data sheet
		1-0	POWER_DOWN_SLOT_15_DURATION	see register map on data sheet

4.6 Configuring Multi-Funtion pins

The TPS65219 PMIC has three configurable multi function pins. MODE/STBY and MODE/RESET that can be configured as MODE to select the switching, as STBY to trigger a transition to Standby state or as RESET to trigger a cold or warm reset. The VSEL_SD/VSEL_DDR pin can be configured to set the output voltage on LDO1 or LDO2 (selectable) or to set the output voltage on Buck3. Refer to the data sheet for information on pin polarity.

Note

If VSEL_SD/VSEL_DDR is not used to set the output voltage on LDO1 (or LDO2), then it must be configured as DDR and pulled to GND with a pull-down resistor in the schematic. Additionally, VSEL_SD_I2C_CTRL must be programmed to 1h.

- [Figure 4-7](#) shows the settings to be changed when using the TPS65219-GUI
- [Figure 4-7](#) show the register fields to be written when NOT using the TPS65219-GUI.

Configuration - NVM fields

READ ALL REGISTERS Note: Changing the value in a dropdown menu will cause an immediate I2C write to the associated register unless immediate write setting is changed on Register Map page.

PMIC Status	Power Resources	Sequence	Digital Pins Configuration															
ENABLE MULTI GPIOs																		
EN / PB / VSENSE (pin# 25) Pin Configuration: Enable Deglitch: Short Deglitch FSD: Disable		<table border="1"> <thead> <tr> <th colspan="3">Deglitch Reference</th> </tr> <tr> <th>Pin Configuration</th> <th>Short_deglitch(TYP)</th> <th>Long_deglitch(TYP)</th> </tr> </thead> <tbody> <tr> <td>Enable</td> <td>120us</td> <td>50ms</td> </tr> <tr> <td>VSENSE</td> <td>120us</td> <td>50ms</td> </tr> <tr> <td>Push-Button</td> <td>200ms</td> <td>600ms</td> </tr> </tbody> </table>		Deglitch Reference			Pin Configuration	Short_deglitch(TYP)	Long_deglitch(TYP)	Enable	120us	50ms	VSENSE	120us	50ms	Push-Button	200ms	600ms
Deglitch Reference																		
Pin Configuration	Short_deglitch(TYP)	Long_deglitch(TYP)																
Enable	120us	50ms																
VSENSE	120us	50ms																
Push-Button	200ms	600ms																
VSEL_SD / VSEL_DDR (pin# 12) Pin Configuration: DDR Rail Selection: LDO1 VSEL_SD_POLARITY: 0 Note: See Table "VSEL_SD/VSEL_DDR configuration options" in the data sheet for more information about pin polarity VSEL_SD Control via I2C: 1.8V Note: VSEL_SD Control has no effect if pin 12 configured as SD		MODE / RESET (pin#28) Pin Configuration: MODE Reset Selection: Cold Reset MODE_RESET_POLARITY: 0 Note: See Table "MODE, STBY and RESET configuration" in the data sheet for more information about pin polarity																
		MODE / STBY (pin# 31) Pin Configuration: MODE MODE_STBY_POLARITY: 0 Note: See Table "MODE, STBY and RESET configuration" in the data sheet for more information about pin polarity BUCK MODE Control via I2C: Auto PFM																
GPIO (pin# 16) GPIO Config: Single-device config GPIO Active State: Disabled GPIO_Standby State: Disabled		GPIO1 (pin# 8) GPIO1 Active State: Disabled GPIO1 Standby State: Disabled	GPIO2 (pin# 17) GPIO2 Active State: Disabled GPIO2 Standby State: Disabled															

Figure 4-7. Multi-Function Configuration using the TPS65219-GUI

Table 4-16. NVM registers for VSEL_SD / VSEL_DDR

	Register Address	Bit		Settings
		Bit #	Field Name	
Pin Function	0x1F	0	VSEL_DDR_SD	0h = VSEL pin configured as DDR to set the voltage on Buck3 1h = VSEL pin configured as SD to set the voltage on the VSEL_RAIL
VSEL rail selection		2	VSEL_RAIL	0h = LDO1 1h = LDO2
Pin polarity		1	VSEL_SD_POLARITY	0h = • LOW: 1.8V • HIGH: LDOx_VOUT register 1h = • HIGH: 1.8V • LOW: LDOx_VOUT register

Table 4-17. NVM registers for MODE / STBY

	Register Address	Bit		Settings
		Bit #	Field Name	
Pin Function	0x20	1-0	MODE_STBY_CONFIG	0h = MODE 1h = STBY 2h = MODE and STBY 3h = MODE
Pin Polarity	0x1F	4	MODE_STBY_POLARITY	see register map on data sheet

Table 4-18. NVM registers for MODE / RESET

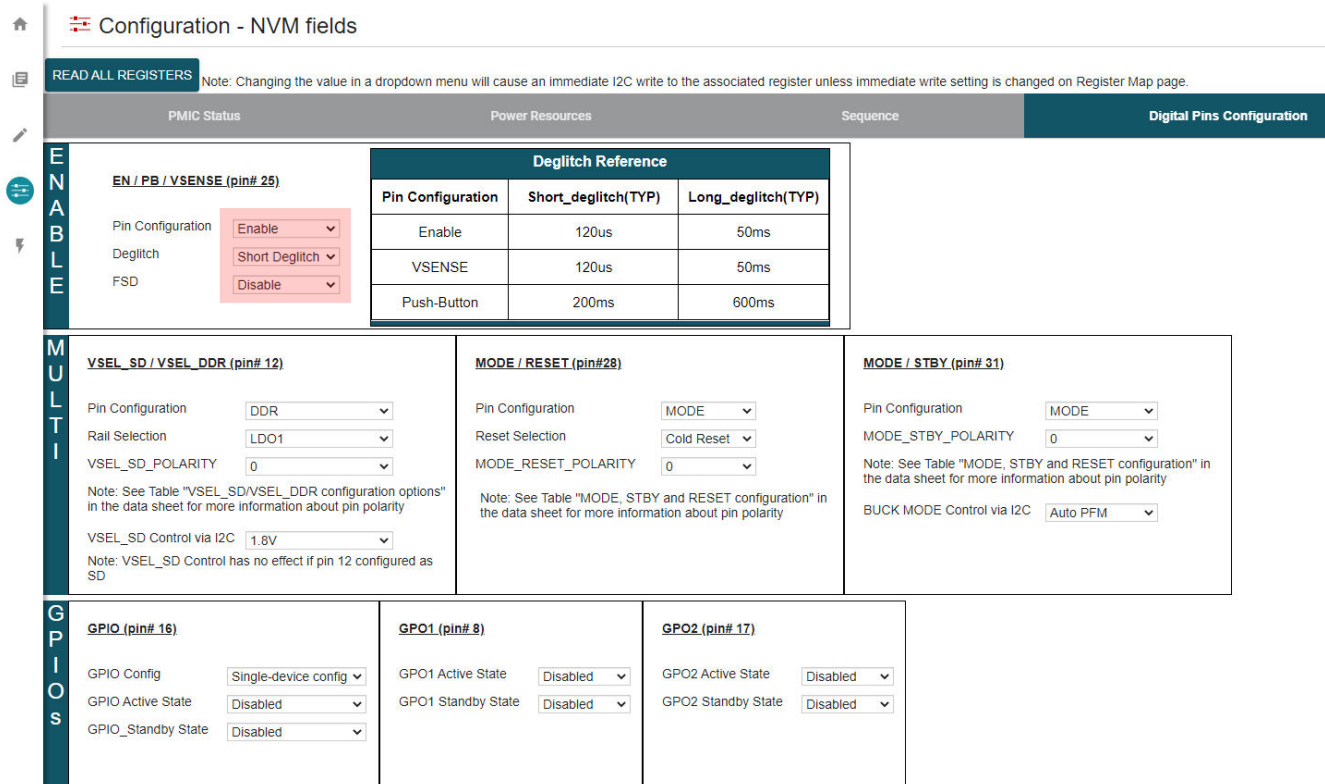
	Register Address	Bit		Settings
		Bit #	Field Name	
Pin Function	0x20	2	MODE_RESET_CONFIG	0h = MODE 1h = RESET
RESET config		6	WARM_COLD_RESET_CONFIG	0h = COLD RESET 1h = WARM RESET
Pin Polarity	0x1F	5	MODE_RESET_POLARITY	see register map on data sheet

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4.7 Configuring the EN/PB/VSENSE pin

The enable pin of the PMIC can be configured as Enable, Push-Button, or VSENSE. In addition to the function, the deglitch can be configured as well. This pin also has the option for first supply detection (FSD) to ignore the state of the EN/PB/VSENSE pin during the first power-up.

- Figure 4-8 shows the settings to be changed when using the TPS65219-GUI.
- Table 4-19 show the register fields to be written when NOT using the TPS65219-GUI.



Configuration - NVM fields

READ ALL REGISTERS Note: Changing the value in a dropdown menu will cause an immediate I2C write to the associated register unless immediate write setting is changed on Register Map page.

PMIC Status Power Resources Sequence **Digital Pins Configuration**

EN / PB / VSENSE (pin# 25)

Pin Configuration: Enable
Deglitch: Short Deglitch
FSD: Disable

Deglitch Reference		
Pin Configuration	Short_deglitch(TYP)	Long_deglitch(TYP)
Enable	120us	50ms
VSENSE	120us	50ms
Push-Button	200ms	600ms

VSEL_SD / VSEL_DDR (pin# 12)

Pin Configuration: DDR
Rail Selection: LDO1
VSEL_SD_POLARITY: 0
Note: See Table "VSEL_SD/VSEL_DDR configuration options" in the data sheet for more information about pin polarity
VSEL_SD Control via I2C: 1.6V
Note: VSEL_SD Control has no effect if pin 12 configured as SD

MODE / RESET (pin# 28)

Pin Configuration: MODE
Reset Selection: Cold Reset
MODE_RESET_POLARITY: 0
Note: See Table "MODE, STBY and RESET configuration" in the data sheet for more information about pin polarity

MODE / STBY (pin# 31)

Pin Configuration: MODE
MODE_STBY_POLARITY: 0
Note: See Table "MODE, STBY and RESET configuration" in the data sheet for more information about pin polarity
BUCK MODE Control via I2C: Auto PFM

GPIO (pin# 16)

GPIO Config: Single-device config
GPIO Active State: Disabled
GPIO_Standby State: Disabled

GPIO1 (pin# 8)

GPIO1 Active State: Disabled
GPIO1 Standby State: Disabled

GPIO2 (pin# 17)

GPIO2 Active State: Disabled
GPIO2 Standby State: Disabled

Figure 4-8. EN/PB/VSENSE configuration using the TPS65219-GUI

Table 4-19. NVM registers for EN / PB / VSENSE

	Register Address	Bit		Settings
		Bit #	Field Name	
First Supply Detection	0x20	7	PU_ON_FSD	0h = FSD Disabled 1h = FSD Enabled
Pin Configuration		5-4	EN_PB_VSENSE_CONFIG	0h = Enable 1h = Push Button 2h = VSENSE 3h = Enable
Deglitch		3	EN_PB_VSENSE_DEGL	see register map on data sheet

4.8 NVM re-programming

Once the register settings are updated, the new values can be saved into the NVM by writing 0x0A to register address 0x34.

Note

TI recommends exporting the selected register settings into a CSV and JSON file using the TPS65219-GUI. Figure 4-10 shows how to export the NVM settings. The file format must be selected on "Register File Fornat" before using the "Save Registers As"

- Figure 4-9 shows the button to save the register settings into the NVM.
- Table 4-20 shows the register field to be written when NOT using the TPS65219-GUI.

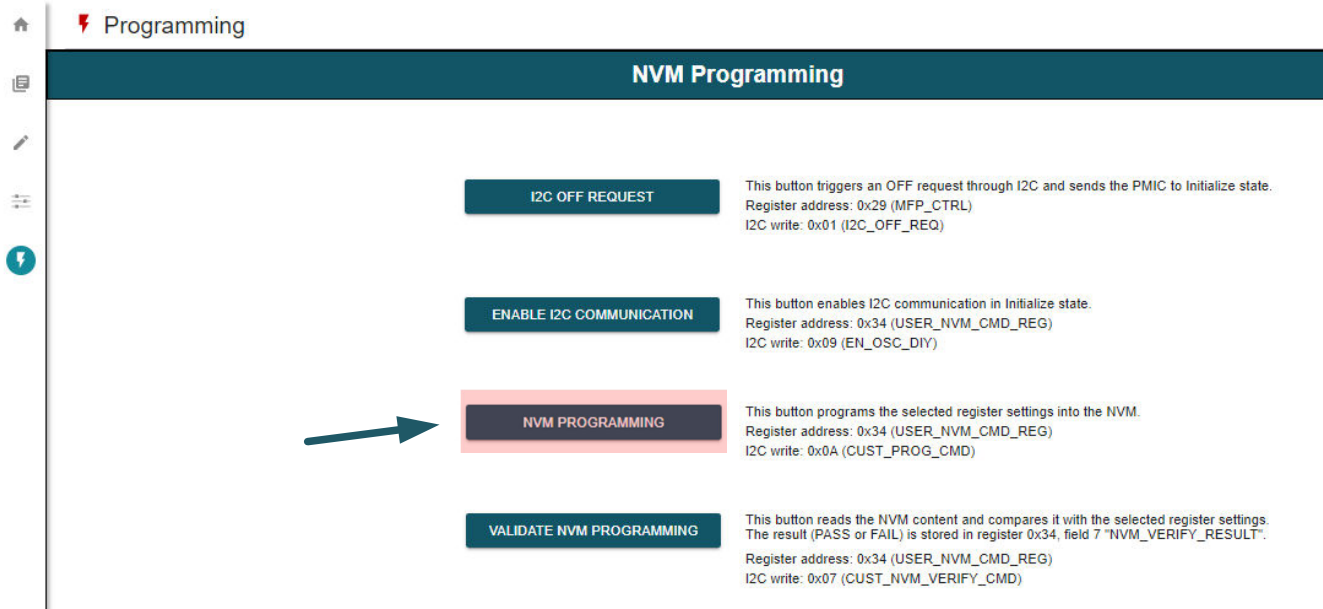


Figure 4-9. NVM re-programming using TPS65219-GUI

Table 4-20. I2C write to save register settings into NVM

Register Address	Bit		Data
	Bit#	Field Name	
0x34	3-0	USER_NVM_CMD	0x0A

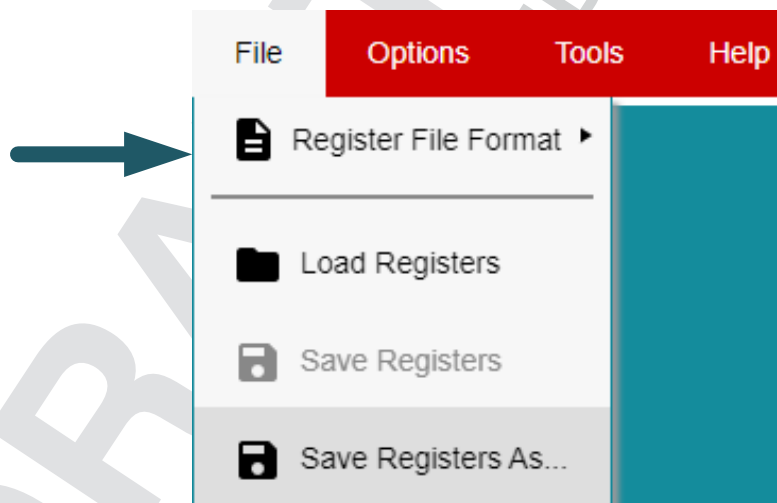


Figure 4-10. Export NVM settings using TPS65219-GUI

A Non-NVM Registers

The PMIC register map contains NVM and non-NVM bits. Registers address 0x00 to 0x27 contains the NVM bits which are the ones backed up by EEPROM. This registers settings can be changed by I2C and default values can be re-programmed as described in the programming guide. The reset value for each of the NVM bits is marked as "X" in the data sheet register map as those can be re-programmed and are unique for each orderable part number.

Non-NVM bits are located in register address 0x28 to 0x41. These registers settings can be changed by I2C but the default values cannot be re-program. Register settings for non-NVM bits go back to their default values after a power cycle and everytime the PMIC enters Initialize state. The default value for non-NVM bits can be found in the data sheet register map, under "Reset" column.

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B References

1. Texas Instruments, TPS6521905 data sheet
2. Texas Instruments, TPS65219EVM user's guide
3. Texas Instruments, TPS65219EVM-SKT user's guide

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